Agilent ABA-51563
3.5 GHz Broadband Silicon RFIC Amplifier

Data Sheet

Features

- Operating frequency: DC ~ 3.5 GHz
- 21.5 dB gain
- VSWR < 2.0 throughout operating frequency
- 1.8 dBm output P1dB
- 3.7 dB noise figure
- Unconditionally stable
- Single 5V supply (Id = 18 mA)
- Lead-free option available

Applications

- Amplifier for cellular, cordless, special mobile radio, PCS, ISM, wireless LAN, DBS, TVRO, and TV tuner applications

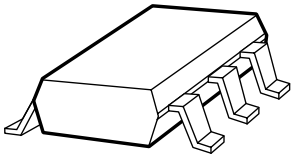
Description

Agilent's ABA-51563 is an economical, easy-to-use, internally 50-ohm matched silicon monolithic broadband amplifier that offers excellent gain and flat broadband response from DC to 3.5 GHz. Packaged in an ultra-miniature industry-standard SOT-363 package, it requires half the board space of a SOT-143 package.

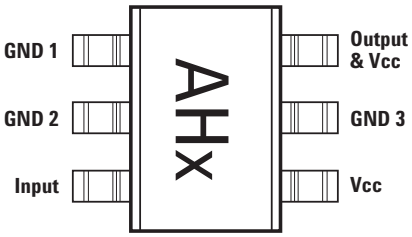
At 2 GHz, the ABA-51563 offers a small-signal gain of 21.5 dB, output P1dB of 1.8 dBm and 11.4 dBm output third order intercept point. It is suitable for use as buffer amplifiers for wideband applications. They are designed for low cost gain blocks in cellular applications, DBS tuners, LNB and other wireless communications systems.

ABA-51563 is fabricated using Agilent's HP25 silicon bipolar process, which employs a double-diffused single polysilicon process with self-aligned submicron emitter geometry. The process is capable of simultaneous high f_T and high NPN breakdown (25 GHz f_T at 6V BVCEO). The process utilizes industry standard device oxide isolation technologies and submicron aluminum multilayer interconnect to achieve superior performance, high uniformity, and proven reliability.

Surface Mount Package SOT-363 / SC70

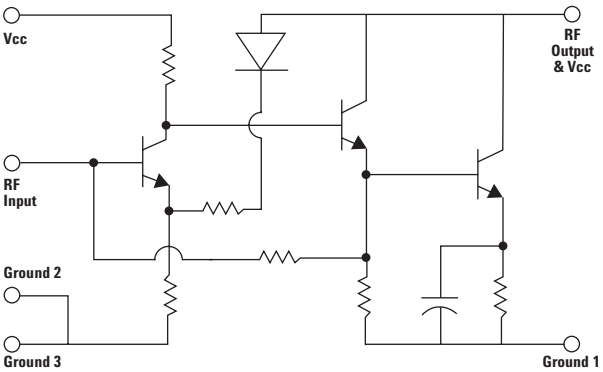


Pin Connections and Package Marking



Note:
Top View. Package marking provides orientation and identification. "x" is character to identify date code.

Simplified Schematic



Attention:
Observe precautions for handling electrostatic sensitive devices.

ESD Machine Model (Class A)

ESD Human Body Model (Class 1A)

Refer to Agilent Application Note A004R: Electrostatic Discharge Damage and Control.

Agilent Technologies

ABA-51563 Absolute Maximum Ratings[1]

Symbol	Parameter	Units	Absolute Max.
V_{cc}	Device Voltage, RF output to ground (T = 25°C)	V	+7
P_{in}	CW RF Input Power (Vcc = 5V)	dBm	+20
P_{diss}	Total Power Dissipation[3]	W	0.3
T_j	Junction Temperature	°C	150
T_{STG}	Storage Temperature	°C	-65 to 150

Thermal Resistance[2] (Vcc = 5V)
θ_{jc} = 104°C/W

Notes:
1. Operation of this device in excess of any of these limits may cause permanent damage.
2. Thermal resistance measured using 150°C Liquid Crystal Measurement Technique.
3. Board (package belly) temperature, Tb, is 25°C. Derate 2.3 mW/°C for Tb > 120.8°C.

Electrical Specifications

T_c = +25°C, Z_o = 50 Ω, P_{in} = -30 dBm, V_{cc} = 5V, Freq = 2 GHz, unless stated otherwise.

Symbol	Parameter and Test Condition	Units	Min.	Typ.	Max.	Std Dev.
Gp[1]	Power Gain ($\|S_{21}\|^2$)	dB	20	21.5		0.2
ΔGp	Power Gain Flatness, f = 0.1 ~ 2.5 GHz f = 0.1 ~ 3.5 GHz	dB		1.0 1.3		
NF[1]	Noise Figure	dB		3.7	4	0.12
P1dB[1]	Output Power at 1dB Gain Compression	dBm		1.8		0.13
OIP3[1]	Output Third Order Intercept Point	dBm		11.4		0.24
$VSWR_{in}$[1]	Input VSWR			1.2		
$VSWR_{out}$[1]	Output VSWR			1.2		
Icc[1]	Device Current	mA		18	28	0.3
td[1]	Group Delay	ps		140		

Notes:
1. Measurements taken on 50Ω test board shown on Figure 1. Excess circuit losses had been de-embedded from actual measurements. Standard deviation and typical data based on at least 500 parts sample size from 6 wafer lots. Future wafers allocated to this product may have nominal values anywhere within the upper and lower spec limits.

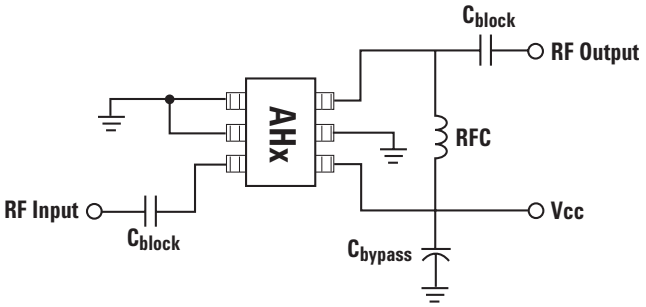


Figure 1. ABA-51563 Production Test Circuit.

ABA-51563 Typical Performance

T_c = +25°C, Z_o = 50Ω, V_{cc} = 5V unless stated otherwise.

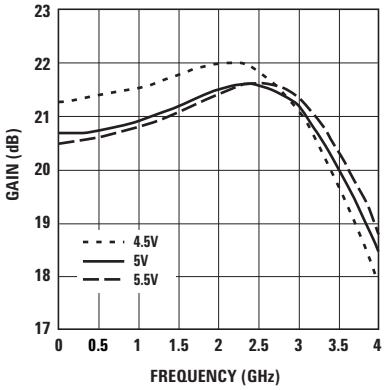


Figure 2. Gain vs. Frequency and Voltage.

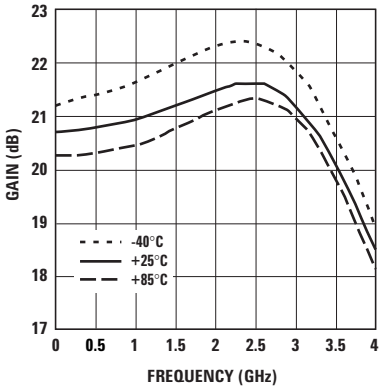


Figure 3. Gain vs. Frequency and Temperature.

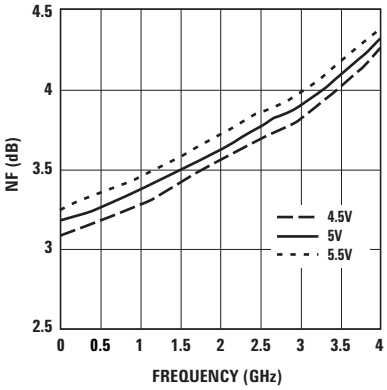


Figure 4. Noise Figure vs. Frequency and Voltage.

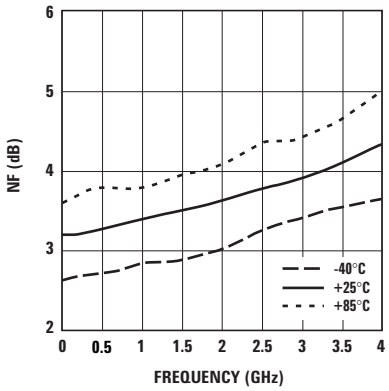


Figure 5. Noise Figure vs. Frequency and Temperature.

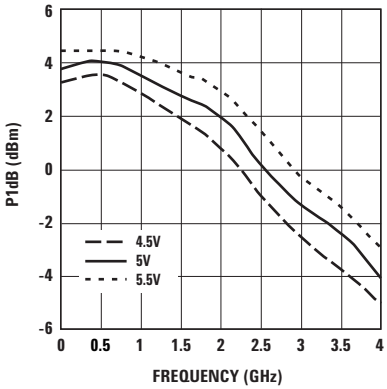


Figure 6. Output Power for 1 dB Gain Compression vs. Frequency and Voltage.

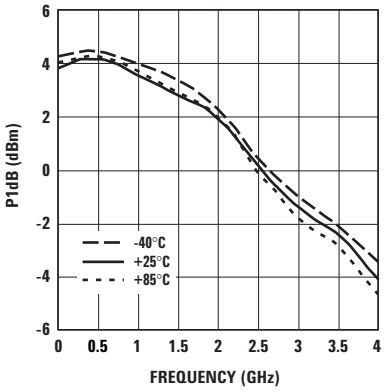


Figure 7. Output Power for 1 dB Gain Compression vs. Frequency and Temperature.

ABA-51563 Typical Performance, continued

T_c = +25°C, Z_o = 50Ω, V_{cc} = 5V unless stated otherwise.

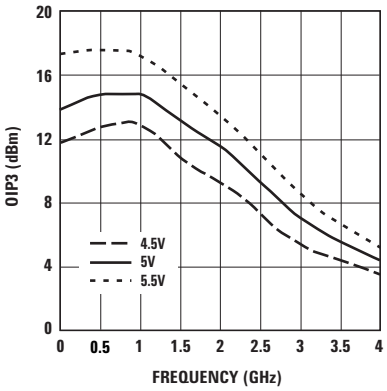


Figure 8. Output IP3 vs. Frequency and Voltage.

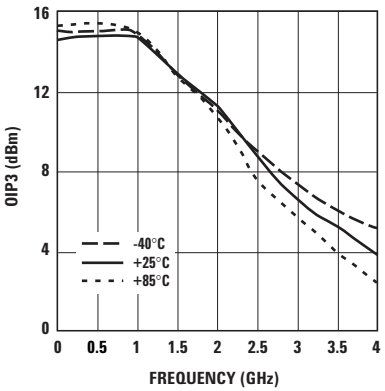


Figure 9. Output IP3 vs. Frequency and Temperature.

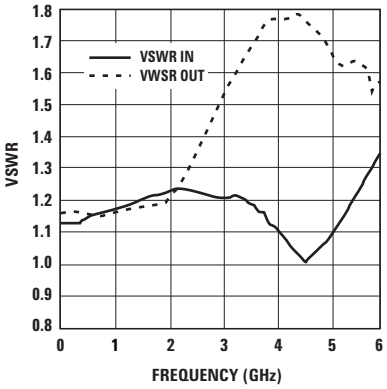


Figure 10. Input and Output VSWR vs. Frequency.

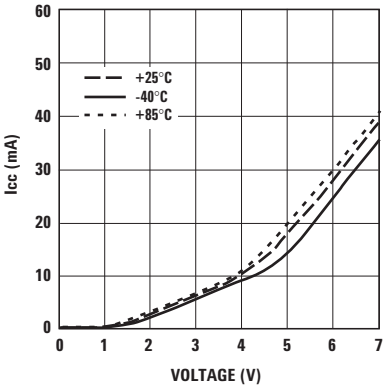


Figure 11. Supply Current vs. Voltage and Temperature.

ABA-51563 Typical Scattering Parameters

T_C = +25°C, V_{CC} = 5V, Z_O = 50 Ω, unless stated otherwise

Freq (GHz)	S_{11} Mag.	S_{11} Ang.	S_{21} dB	S_{21} Mag.	S_{21} Ang.	S_{12} dB	S_{12} Mag.	S_{12} Ang.	S_{22} Mag.	S_{22} Ang.	K Factor
0.05	0.06	175.8	20.8	10.93	-2.3	-27.3	0.04	-0.8	0.08	-2.3	1.294
0.10	0.06	174.1	20.7	10.88	-4.4	-27.3	0.04	-1.4	0.08	-6.0	1.297
0.20	0.06	170.4	20.8	10.93	-8.6	-27.5	0.04	-2.5	0.07	-11.5	1.313
0.30	0.06	166.0	20.8	10.93	-12.8	-27.5	0.04	-3.3	0.07	-15.1	1.313
0.40	0.06	160.6	20.8	10.97	-17.1	-27.7	0.04	-3.8	0.07	-17.7	1.331
0.50	0.07	161.9	20.8	10.97	-21.4	-27.7	0.04	-4.1	0.07	-17.7	1.330
0.60	0.07	160.0	20.8	10.99	-25.6	-28.0	0.04	-4.6	0.07	-17.8	1.351
0.70	0.07	155.8	20.9	11.04	-30.0	-28.0	0.04	-4.8	0.07	-18.9	1.346
0.80	0.08	153.5	20.9	11.10	-34.2	-28.2	0.04	-5.0	0.07	-18.5	1.365
0.90	0.08	150.4	20.9	11.13	-38.6	-28.2	0.04	-4.9	0.07	-14.7	1.361
1.00	0.08	148.0	21.0	11.20	-43.0	-28.4	0.04	-4.9	0.08	-9.9	1.380
1.20	0.08	132.5	21.1	11.35	-52.0	-28.6	0.04	-4.4	0.08	11.6	1.391
1.40	0.09	118.9	21.2	11.51	-61.1	-28.9	0.04	-3.8	0.08	26.1	1.403
1.60	0.09	102.9	21.4	11.69	-70.7	-28.9	0.04	-2.7	0.08	37.7	1.386
1.80	0.10	86.5	21.5	11.85	-80.6	-29.1	0.04	-1.3	0.09	44.3	1.399
2.00	0.10	69.6	21.5	11.94	-90.7	-29.1	0.04	0.3	0.10	47.9	1.391
2.20	0.11	50.6	21.6	12.04	-101.2	-29.1	0.04	1.9	0.11	45.1	1.382
2.40	0.10	38.4	21.7	12.15	-112.1	-29.1	0.04	3.0	0.13	41.1	1.369
2.60	0.10	30.1	21.7	12.14	-123.5	-28.9	0.04	4.3	0.16	36.7	1.339
2.80	0.10	17.8	21.6	12.00	-135.3	-28.9	0.04	5.7	0.19	31.6	1.341
3.00	0.09	10.2	21.4	11.70	-147.3	-28.9	0.04	7.4	0.21	26.7	1.354
3.20	0.10	-1.1	21.0	11.27	-158.9	-28.6	0.04	9.8	0.24	21.4	1.352
3.40	0.09	-15.7	20.6	10.73	-170.5	-28.2	0.04	10.8	0.25	14.4	1.343
3.50	0.08	-20.5	20.4	10.45	-176.2	-28.0	0.04	11.4	0.26	11.2	1.337
4.00	0.05	-52.8	18.9	8.86	157.4	-27.1	0.04	12.4	0.27	-4.6	1.389
4.50	0.00	-179.7	17.4	7.40	133.1	-26.2	0.05	12.3	0.27	-18.4	1.457
5.00	0.04	127.8	15.6	6.06	112.1	-25.2	0.06	11.0	0.24	-32.2	1.568
5.50	0.10	114.7	14.1	5.09	92.7	-24.0	0.06	7.2	0.24	-47.4	1.597
6.00	0.16	105.3	12.7	4.30	75.7	-23.0	0.07	1.9	0.20	-62.0	1.657

Device Models

Refer to Agilent's web site
www.agilent.com/view/rf

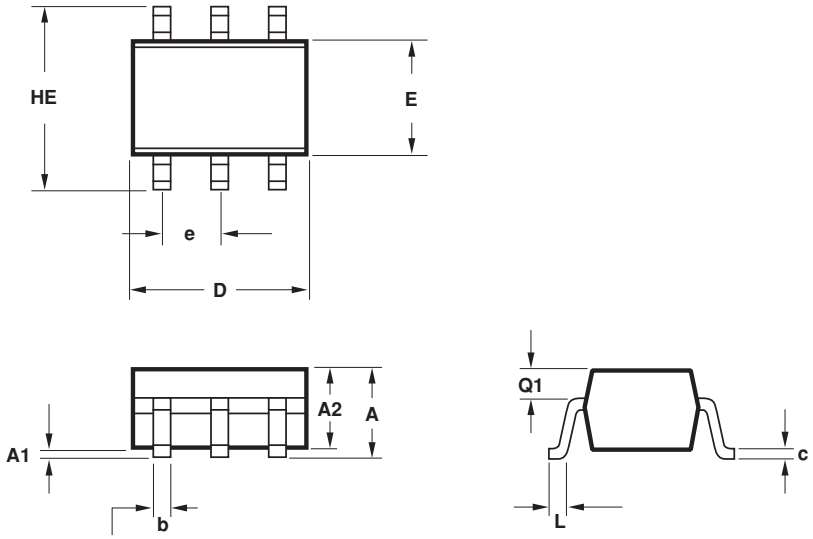
Ordering Information

Part Number	Devices per Container	Container
ABA-51563-TR1	3000	7" reel
ABA-51563-TR2	10000	13" reel
ABA-51563-BLK	100	antistatic bag
ABA-51563-TR1G	3000	7" reel
ABA-51563-TR2G	10000	13" reel
ABA-51563-BLKG	100	antistatic bag

Note: For lead-free option,the part number will have the character "G" at the end.

Package Dimensions

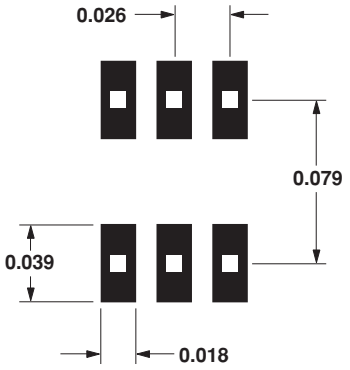
Outline 63 (SOT-363/SC-70)



SYMBOL	DIMENSIONS (mm) MIN.	MAX.
E	1.15	1.35
D	1.80	2.25
HE	1.80	2.40
A	0.80	1.10
A2	0.80	1.00
A1	0.00	0.10
Q1	0.10	0.40
e	0.650 BCS	
b	0.15	0.30
c	0.10	0.20
L	0.10	0.30

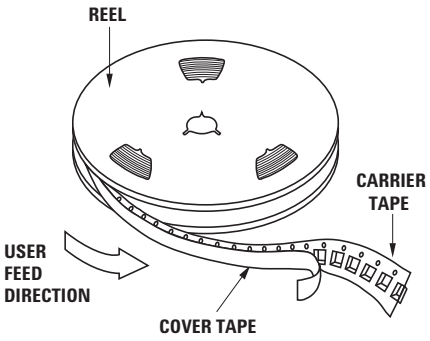
NOTES:
1. All dimensions are in mm.
2. Dimensions are inclusive of plating.
3. Dimensions are exclusive of mold flash & metal burr.
4. All specifications comply to EIAJ SC70.
5. Die is facing up for mold and facing down for trim/form, ie: reverse trim/form.
6. Package surface to be mirror finish.

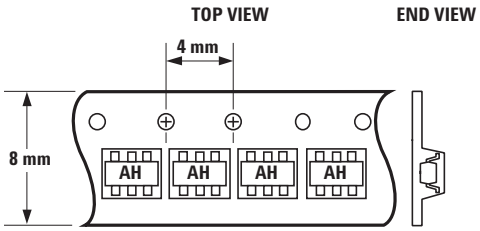
Recommended PCB Pad Layout for Agilent's SC70 6L/SOT-363 Products



Dimensions in inches.

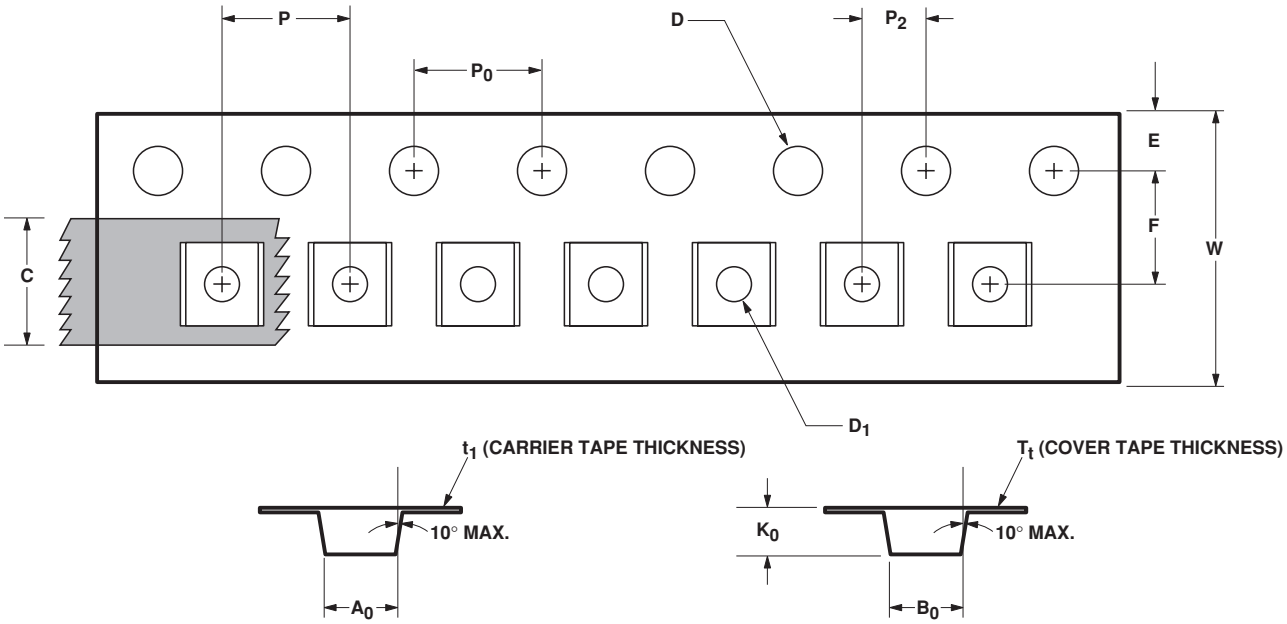
Device Orientation





(Package marking example orientation shown.)

Tape Dimensions and Product Orientation for Outline 63



DESCRIPTION		SYMBOL	SIZE (mm)	SIZE (INCHES)
CAVITY	LENGTH	A_0	2.40 ± 0.10	0.094 ± 0.004
	WIDTH	B_0	2.40 ± 0.10	0.094 ± 0.004
	DEPTH	K_0	1.20 ± 0.10	0.047 ± 0.004
	PITCH	P	4.00 ± 0.10	0.157 ± 0.004
	BOTTOM HOLE DIAMETER	D_1	1.00 + 0.25	0.039 + 0.010
PERFORATION	DIAMETER	D	1.50 ± 0.10	0.061 + 0.002
	PITCH	P_0	4.00 ± 0.10	0.157 ± 0.004
	POSITION	E	1.75 ± 0.10	0.069 ± 0.004
CARRIER TAPE	WIDTH	W	8.00 + 0.30 - 0.10	0.315 + 0.012
	THICKNESS	t_1	0.254 ± 0.02	0.0100 ± 0.0008
COVER TAPE	WIDTH	C	5.40 ± 0.10	0.205 + 0.004
	TAPE THICKNESS	T_t	0.062 ± 0.001	0.0025 ± 0.0004
DISTANCE	CAVITY TO PERFORATION (WIDTH DIRECTION)	F	3.50 ± 0.05	0.138 ± 0.002
	CAVITY TO PERFORATION (LENGTH DIRECTION)	P_2	2.00 ± 0.05	0.079 ± 0.002

www.agilent.com/semiconductors

For product information and a complete list of distributors, please go to our web site.

For technical assistance call:

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China: 10800 650 0017

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Japan: (+81 3) 3335-8152(Domestic/International), or 0120-61-1280(Domestic Only)

Korea: (65) 6755 1989

Singapore, Malaysia, Vietnam, Thailand, Philippines, Indonesia: (65) 6755 2044

Taiwan: (65) 6755 1843

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December 4, 2004
5989-1970EN

Agilent Technologies

ООО «ЛайфЭлектроникс» “LifeElectronics” LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

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- *Тестирование поставляемой продукции.*
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